Tyrone Camarero Specifications

Tyrone

Camarero DS400TTP-224R

Key features

Compute Intensive Application, HPC, Data Center, Enterprise Server, Financial Analysis, Mission-critical applications Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable
 Processors.Dual Socket P (LGA 3647) supported, CPU TDP support 165W TDP, 2 UPI up to 10.4 GT/s
- Intel ®C621 chipset
- Up to 4TB 3DS ECC RDIMM, DDR4-2933MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-2933MHz, in
 16 DIMM slots; Up to 2TB Intel® Optane™ DC Persistent Memory in memory mode (Cascade Lake only)
- 2 PCI-E 3.0 x16 slots
- Flexible Networking support via SIOM; Dedicated IPMI 2.0 LAN
- 6 Hot-swap 2.5" SATA3 drive bays
- 2200W Redundant Power Supplies Titanium Level (96%)





Processor/Cache

Processor 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel®

Xeon® Scalable Processors.Dual Socket P (LGA 3647) supported, CPU TDP support 165W TDP, 2 UPI up to

10.4 GT/s

Chipset

Chipset Intel *C621 chipset

System Memory

Memory Capacity Up to 4TB 3DS ECC RDIMM, DDR4-

2933MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-2933MHz, in 16 DIMM slots;Up to 2TB Intel® Optane™ DC Persistent

Memory in memory mode (Cascade Lake only)

Expansion Slots

PCI-Express 2 PCI-E 3.0 x16 slots

Integrated On-Board

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10

LAN 1 RJ45 Dedicated IPMI LAN port

Add-on Options

Raid Card Optional Optical Drive None **Front Panel**

LED Indicators Power status LED, HDD activity LED,

Network activity LEDs,

Universal Information (UID) LED

Buttons Power On/Off button, UID button

Drive Bays

HDD Bays 6 Hot-swap 2.5" SATA3 drive bays

Power Supply

2200W Redundant Power Supplies Titanium Level (96%)

Cooling System

4 Heavy duty 8cm PWM fans with optimal fan speed control

Form Factor

Form Factor 2U Rackmount

Height : 3.47" (88mm), Width : 17.25" (438mm), Depth : 28.5" (724mm)

Email: info@tyronesystems.com

For more/current product information, visit

www.tyronesystems.com

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